

## Complementary Enhancement Mode MOSFET

### 1. Product Information

#### 1.1 Features

- ☒ Surface-mounted package
- ☒ Advanced trench cell design

#### 1.2 Applications

- ☒ MB and NB
- ☒ Motor drivers
- ☒ Half – bridge Drivers

#### 1.3 Quick reference

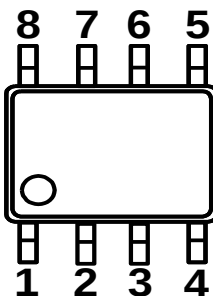
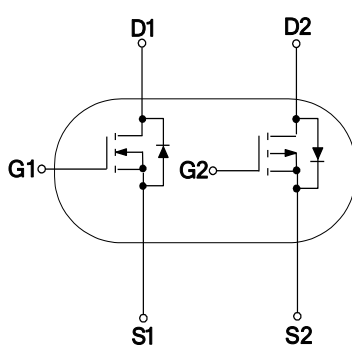
##### N-channel

- ☒  $BV \leq 60\text{ V}$
- ☒  $P_{tot} \leq 2\text{ W}$
- ☒  $I_D \leq 5.9\text{ A}$
- ☒  $R_{DS(ON)} \leq 35\text{ m}\Omega @ V_{GS} = 10\text{ V}$   
 $R_{DS(ON)} \leq 45\text{ m}\Omega @ V_{GS} = 4.5\text{ V}$

##### P-channel

- ☒  $BV \leq -60\text{ V}$
- ☒  $P_{tot} \leq 2\text{ W}$
- ☒  $I_D \leq -4.4\text{ A}$
- ☒  $R_{DS(ON)} \leq 60\text{ m}\Omega @ V_{GS} = -10\text{ V}$   
 $R_{DS(ON)} \leq 78\text{ m}\Omega @ V_{GS} = -4.5\text{ V}$

### 2. Pin Description

| Pin | Description | Simplified Outline                                                                                             | Symbol                                                                                |
|-----|-------------|----------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|
| 1   | Source(S1)  |  <p>Top View<br/>SOP-8L</p> |  |
| 2   | Gate(G1)    |                                                                                                                |                                                                                       |
| 3   | Source(S2)  |                                                                                                                |                                                                                       |
| 4   | Gate(G2)    |                                                                                                                |                                                                                       |
| 5,6 | Drain(D2)   |                                                                                                                |                                                                                       |
| 7,8 | Drain(D1)   |                                                                                                                |                                                                                       |
|     |             |                                                                                                                |                                                                                       |

## 3. Limiting Values

| Symbol            | Parameter                               | Conditions                                                 | Min  | Max      | Unit                          |
|-------------------|-----------------------------------------|------------------------------------------------------------|------|----------|-------------------------------|
| <b>N-channel</b>  |                                         |                                                            |      |          |                               |
| $V_{DS}$          | Drain-Source Voltage                    | $T_A = 25\text{ }^{\circ}\text{C}$                         | 60   | -        | V                             |
| $V_{GS}$          | Gate-Source Voltage                     | $T_A = 25\text{ }^{\circ}\text{C}$                         | -    | $\pm 20$ | V                             |
| $I_D^*$           | Drain Current                           | $T_A = 25\text{ }^{\circ}\text{C}, V_{GS} = -10\text{ V}$  | -    | 5.9      | A                             |
|                   |                                         | $T_A = 100\text{ }^{\circ}\text{C}, V_{GS} = -10\text{ V}$ | -    | 3.7      | A                             |
| $I_{DM}^{*,**}$   | Pulsed Drain Current                    | $T_A = 25\text{ }^{\circ}\text{C}, V_{GS} = -10\text{ V}$  | -    | 23.6     | A                             |
| <b>P-channel</b>  |                                         |                                                            |      |          |                               |
| $V_{DS}$          | Drain-Source Voltage                    | $T_A = 25\text{ }^{\circ}\text{C}$                         | - 60 | -        | V                             |
| $V_{GS}$          | Gate-Source Voltage                     | $T_A = 25\text{ }^{\circ}\text{C}$                         | -    | $\pm 20$ | V                             |
| $I_D^*$           | Drain Current                           | $T_A = 25\text{ }^{\circ}\text{C}, V_{GS} = -10\text{ V}$  | -    | - 4.4    | A                             |
|                   |                                         | $T_A = 100\text{ }^{\circ}\text{C}, V_{GS} = -10\text{ V}$ | -    | - 2.8    | A                             |
| $I_{DM}^{*,**}$   | Pulsed Drain Current                    | $T_A = 25\text{ }^{\circ}\text{C}, V_{GS} = -10\text{ V}$  | -    | - 17.6   | A                             |
| $P_{tot}$         | Total Power Dissipation                 | $T_A = 25\text{ }^{\circ}\text{C}$                         | -    | 2        | W                             |
| $T_{stg}$         | Storage Temperature                     |                                                            | - 55 | 150      | $^{\circ}\text{C}$            |
| $T_J$             | Junction Temperature                    |                                                            | - 55 | 150      | $^{\circ}\text{C}$            |
| $R_{\theta JA}^*$ | Thermal Resistance- Junction to Ambient |                                                            | -    | 62.5     | $^{\circ}\text{C} / \text{W}$ |

Notes :

\* Surface Mounted on 1 in<sup>2</sup> pad area,  $t \leq 10\text{ sec}$

\*\* Pulse width  $\leq 10\text{ }\mu\text{s}$ , duty cycle  $\leq 1\%$

## 4. Marking Information

| Product Name | Marking                                                        |
|--------------|----------------------------------------------------------------|
| KJ4716S      | <div>4716</div> <div>YWWXXX</div> <div>YWWXXX: Date Code</div> |

## 5. Ordering Code

| Product Name | Package | Reel Size | Tape width | Quantity | Note |
|--------------|---------|-----------|------------|----------|------|
| KJ4716S      | SOP8    |           |            | 3000     |      |

Note: KUAJIEXIN defines " Green " as lead-free ( RoHS compliant ) and halogen free ( Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC / JEDEC J-STD-020C )

## 6. Electrical Characteristics (T<sub>A</sub> = 25 °C Unless Otherwise Noted)

### N-channel:

| Symbol                                   | Parameter                        | Conditions                                                                                                               | Min | Typ  | Max  | Unit |
|------------------------------------------|----------------------------------|--------------------------------------------------------------------------------------------------------------------------|-----|------|------|------|
| Static Characteristics                   |                                  |                                                                                                                          |     |      |      |      |
| BV <sub>DSS</sub>                        | Drain-Source Breakdown Voltage   | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA                                                                           | 60  | -    | -    | V    |
| V <sub>GS(th)</sub>                      | Gate Threshold Voltage           | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>DS</sub> = 250 μA                                                             | 1   | -    | 2.5  | V    |
| I <sub>DSS</sub>                         | Zero Gate Voltage Source Current | V <sub>DS</sub> = 48 V, V <sub>GS</sub> = 0 V                                                                            | -   | -    | 1    | μA   |
|                                          |                                  | T <sub>J</sub> = 85 °C                                                                                                   | -   | -    | 30   | μA   |
| I <sub>GSS</sub>                         | Gate Leakage Current             | V <sub>GS</sub> = ± 20 V, V <sub>DS</sub> = 0 V                                                                          | -   | -    | ±100 | nA   |
| R <sub>DS(ON)</sub> <sup>a</sup>         | Drain-Source On-State Resistance | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 4 A                                                                             | -   | 30   | 35   | m Ω  |
|                                          |                                  | V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 3 A                                                                            | -   | 38   | 45   |      |
| Diode Characteristics                    |                                  |                                                                                                                          |     |      |      |      |
| V <sub>SD</sub> <sup>a</sup>             | Diode Forward Voltage            | I <sub>SD</sub> = 1 A, V <sub>GS</sub> = 0 V                                                                             | -   | 0.8  | 1.2  | V    |
| t <sub>rr</sub>                          | Reverse Recovery Time            | I <sub>SD</sub> = 4 A, dI <sub>SD</sub> /dt = 100 A/μs                                                                   | -   | 37   | -    | ns   |
| Q <sub>rr</sub>                          | Reverse Recovery Charge          |                                                                                                                          | -   | 3.8  | -    | nC   |
| Dynamic Characteristics <sup>b</sup>     |                                  |                                                                                                                          |     |      |      |      |
| C <sub>iss</sub>                         | Input Capacitance                | V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V<br>Frequency = 1 MHz                                                       | -   | 1042 | -    | pF   |
| C <sub>oss</sub>                         | Output Capacitance               |                                                                                                                          | -   | 48.6 | -    |      |
| C <sub>rss</sub>                         | Reverse Transfer Capacitance     |                                                                                                                          | -   | 38   | -    |      |
| t <sub>d(on)</sub>                       | Turn-on Delay Time               | V <sub>DS</sub> = 30 V, V <sub>GEN</sub> = 10 V,<br>R <sub>G</sub> = 6 Ω, R <sub>L</sub> = 7.5Ω,<br>I <sub>D</sub> = 4 A | -   | 4.8  | -    | ns   |
| t <sub>r</sub>                           | Turn-on Rise Time                |                                                                                                                          | -   | 18.5 | -    |      |
| t <sub>d(off)</sub>                      | Turn-off Delay Time              |                                                                                                                          | -   | 14.5 | -    |      |
| t <sub>f</sub>                           | Turn-off Fall Time               |                                                                                                                          | -   | 18   | -    |      |
| Gate Charge Characteristics <sup>b</sup> |                                  |                                                                                                                          |     |      |      |      |
| Q <sub>g</sub>                           | Total Gate Charge                | V <sub>DS</sub> =30 V, V <sub>GS</sub> = 10 V,<br>I <sub>DS</sub> = 4 A                                                  | -   | 19   | -    | nC   |
| Q <sub>gs</sub>                          | Gate-Source Charge               |                                                                                                                          | -   | 4.2  | -    |      |
| Q <sub>gd</sub>                          | Gate-Drain Charge                |                                                                                                                          | -   | 2.6  | -    |      |

Notes :

a : Pulse test ; pulse width ≤ 300 μs, duty cycle ≤ 2 %

b : Guaranteed by design, not subject to production testing

## 7. Electrical Characteristics (T<sub>A</sub>=25 °C Unless Otherwise Noted)

### P-channel:

| Symbol                                   | Parameter                      | Conditions                                                                                                                       | Min. | Typ.  | Max.  | Unit |
|------------------------------------------|--------------------------------|----------------------------------------------------------------------------------------------------------------------------------|------|-------|-------|------|
| Static Characteristics                   |                                |                                                                                                                                  |      |       |       |      |
| BV <sub>DSS</sub>                        | Drain-Source Breakdown Voltage | V <sub>GS</sub> = 0 V, I <sub>DS</sub> = - 250 μA                                                                                | - 60 | -     | -     | V    |
| V <sub>GS(th)</sub>                      | Gate Threshold Voltage         | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>DS</sub> = - 250 μA                                                                   | - 1  | -     | - 2.5 | V    |
| I <sub>DSS</sub>                         | Drain Leakage Current          | V <sub>DS</sub> = - 48 V, V <sub>GS</sub> = 0 V                                                                                  | -    | -     | - 1.0 | μA   |
| I <sub>GSS</sub>                         | Gate Leakage Current           | V <sub>GS</sub> = 0 V, V <sub>GS</sub> = ± 20 V                                                                                  | -    | -     | ±100  | nA   |
| R <sub>DS(ON)</sub> <sup>a</sup>         | On-State Resistance            | V <sub>GS</sub> = - 10 V, I <sub>DS</sub> = - 3 A                                                                                | -    | 53    | 60    | mΩ   |
|                                          |                                | V <sub>GS</sub> = - 4.5 V, I <sub>DS</sub> = - 2 A                                                                               | -    | 67    | 78    |      |
| Diode Characteristics                    |                                |                                                                                                                                  |      |       |       |      |
| V <sub>SD</sub> <sup>a</sup>             | Diode Forward Voltage          | I <sub>SD</sub> = - 1 A, V <sub>GS</sub> = 0 V                                                                                   | -    | - 0.8 | - 1.2 | V    |
| t <sub>rr</sub>                          | Reverse Recovery Time          | I <sub>SD</sub> = - 3 A, dI <sub>SD</sub> / dt = 100 A / μs                                                                      | -    | 32    | -     | ns   |
| Q <sub>rr</sub>                          | Reverse Recovery Charge        |                                                                                                                                  | -    | 8.5   | -     | nC   |
| Dynamic Characteristics <sup>b</sup>     |                                |                                                                                                                                  |      |       |       |      |
| C <sub>iss</sub>                         | Input Capacitance              | V <sub>GS</sub> = 0 V, V <sub>DS</sub> = - 25 V<br>Frequency = 1 MHz                                                             | -    | 1325  | -     | pF   |
| C <sub>oss</sub>                         | Output Capacitance             |                                                                                                                                  | -    | 75    | -     |      |
| C <sub>rss</sub>                         | Reverse Transfer Capacitance   |                                                                                                                                  | -    | 58    | -     |      |
| t <sub>d(on)</sub>                       | Turn-on Delay Time             | V <sub>DS</sub> = - 30 V, V <sub>GEN</sub> = - 10 V,<br>R <sub>G</sub> = 3.3 Ω, R <sub>L</sub> =10 Ω,<br>I <sub>DS</sub> = - 3 A | -    | 8.6   | -     | ns   |
| t <sub>r</sub>                           | Turn-on Rise Time              |                                                                                                                                  | -    | 30    | -     |      |
| t <sub>d(off)</sub>                      | Turn-off Delay Time            |                                                                                                                                  | -    | 253   | -     |      |
| t <sub>f</sub>                           | Turn-off Fall Time             |                                                                                                                                  | -    | 104   | -     |      |
| Gate Charge Characteristics <sup>b</sup> |                                |                                                                                                                                  |      |       |       |      |
| Q <sub>g</sub>                           | Total Gate Charge              | V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = - 10 V,<br>I <sub>DS</sub> = -3 A                                                    | -    | 25    | -     | nC   |
| Q <sub>gs</sub>                          | Gate-Source Charge             |                                                                                                                                  | -    | 5.8   | -     |      |
| Q <sub>gd</sub>                          | Gate-Drain Charge              |                                                                                                                                  | -    | 3.1   | -     |      |

Notes :

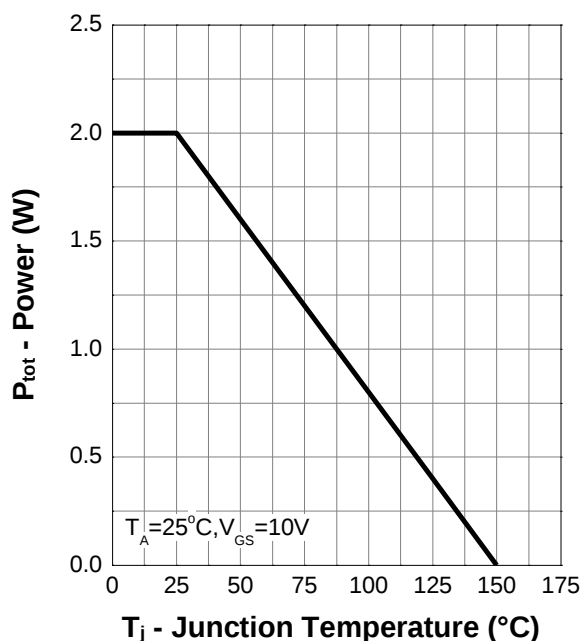
a : Pulse test ; pulse width ≤ 300 μs, duty cycle ≤ 2%

b : Guaranteed by design, not subject to production testing

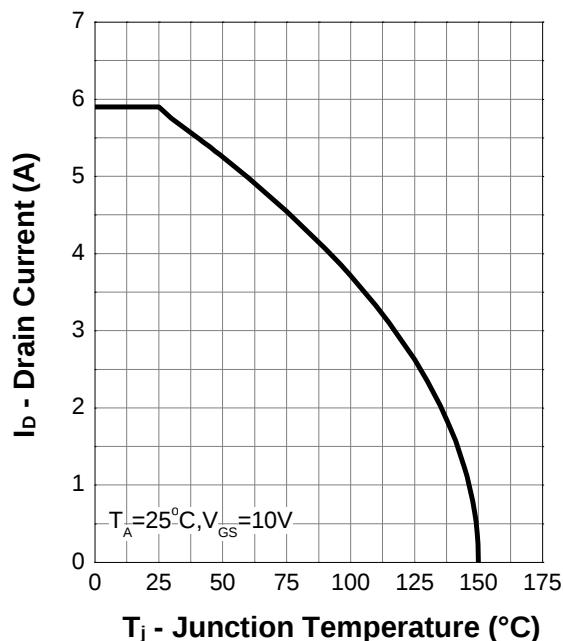
## 8. Typical Characteristics (Cont.)

N-channel:

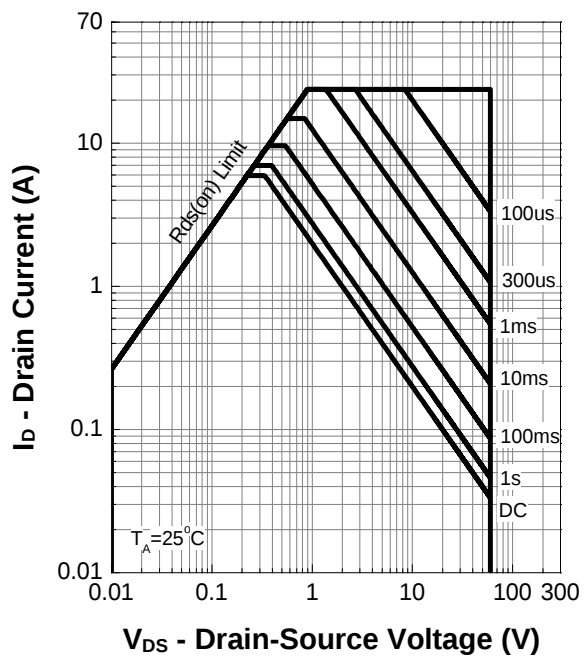
Power Capability



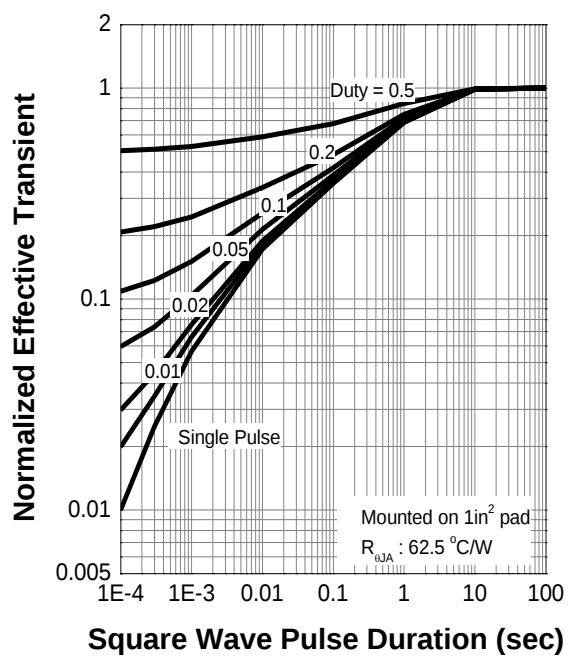
Current Capability



Safe Operatio. ea



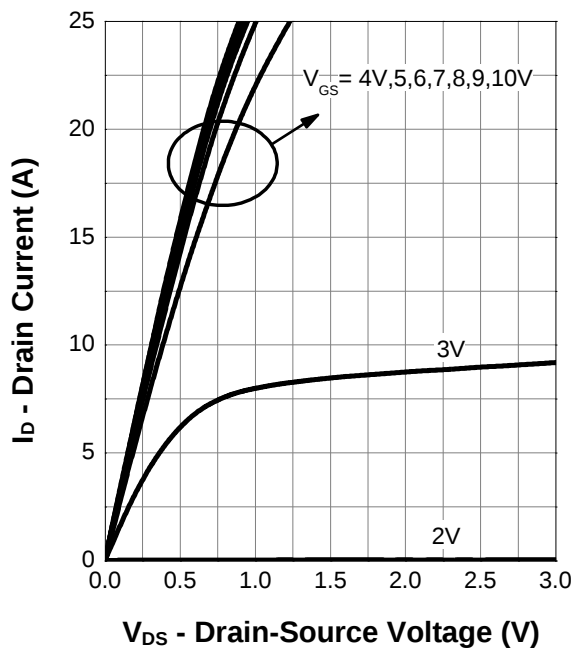
Transient Thermal Impedance



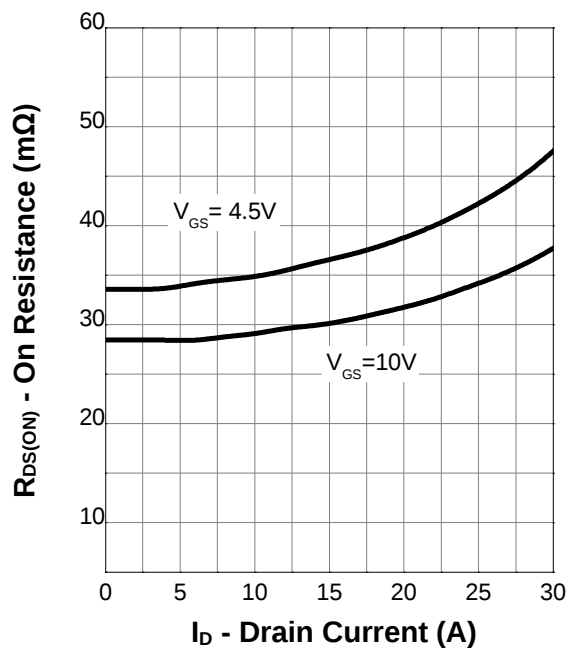
## 8. Typical Characteristics (Cont.)

N-channel:

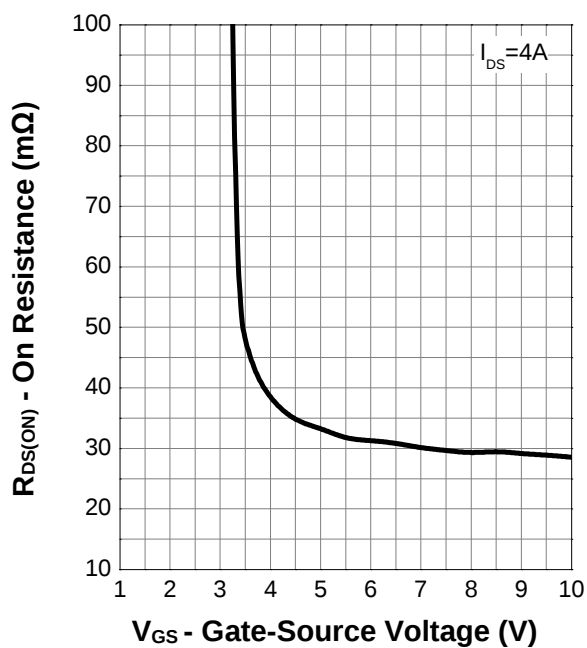
Output Characteristics



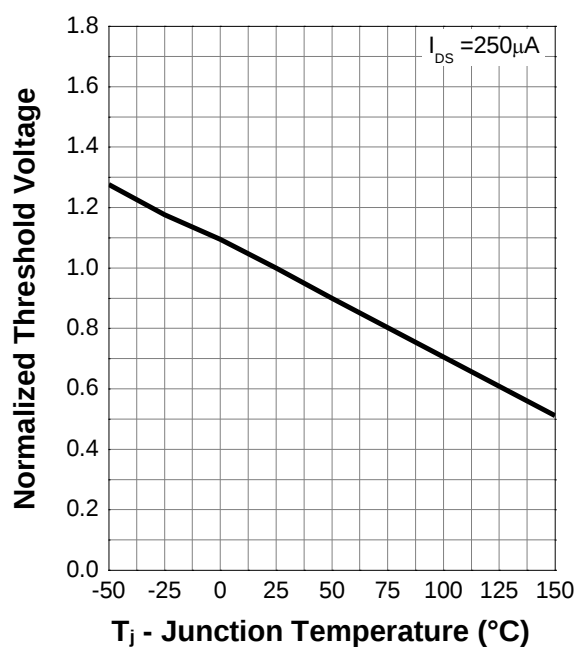
On Resistance



Transfer Characteristics



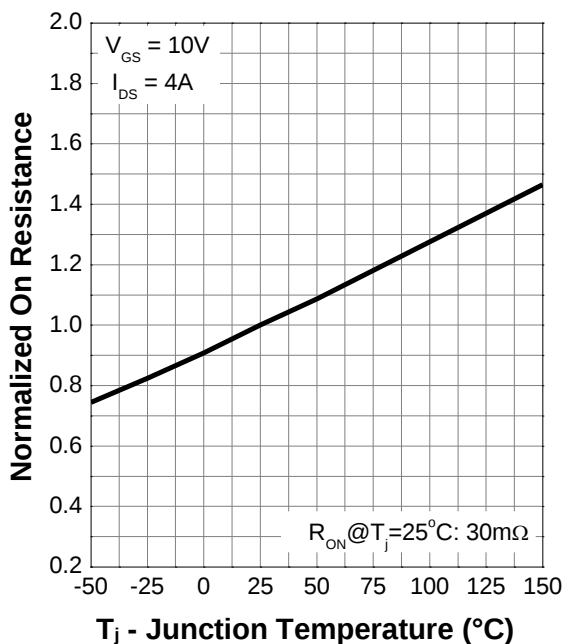
Normalized Threshold Voltage



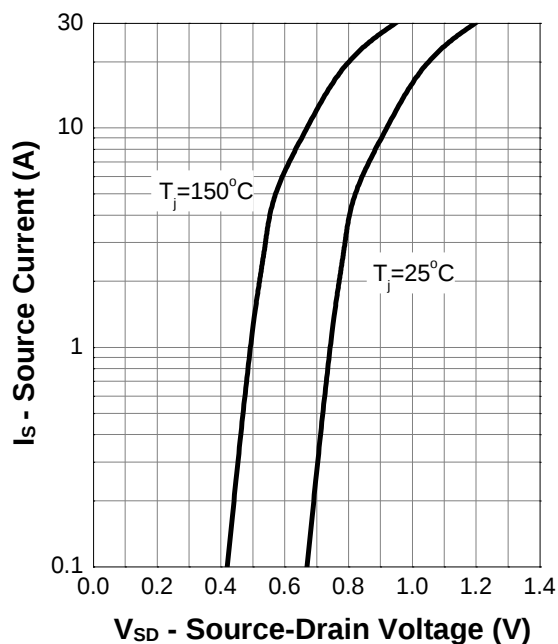
## 8. Typical Characteristics (Cont.)

N-channel:

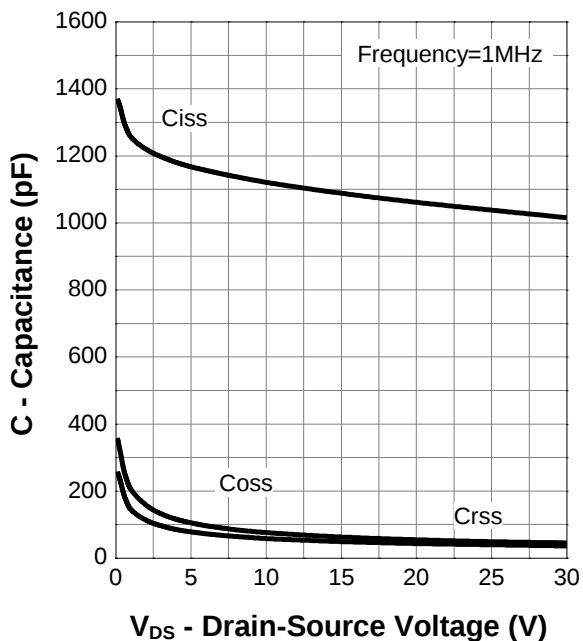
Normalized On Resistance



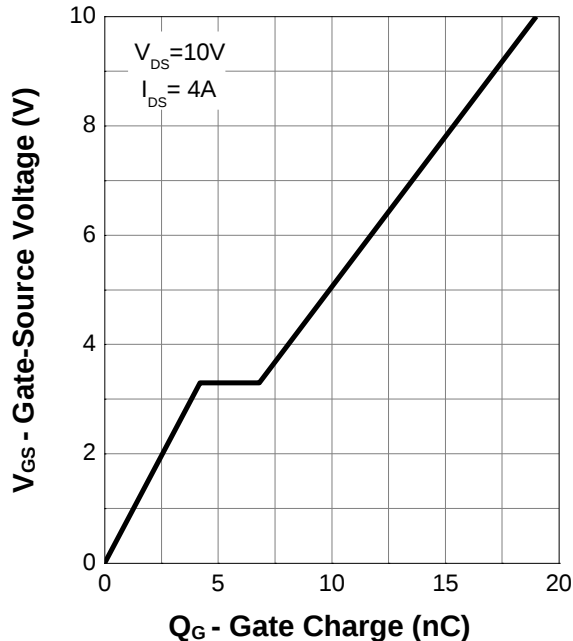
Diode Forward Current



Capacitance



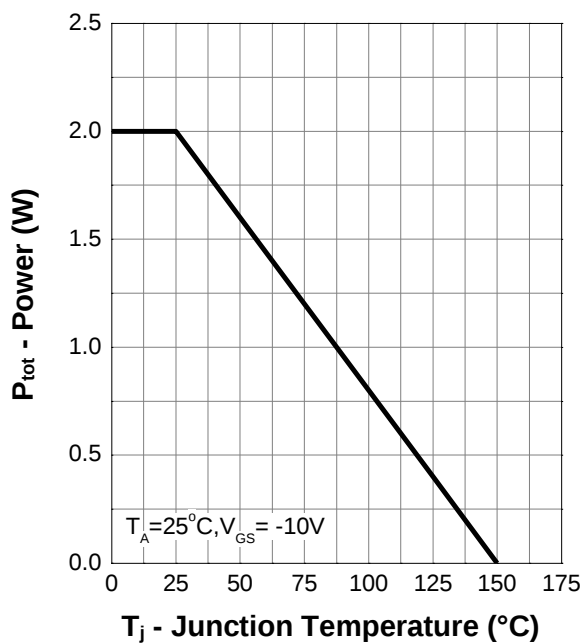
Gate Charge



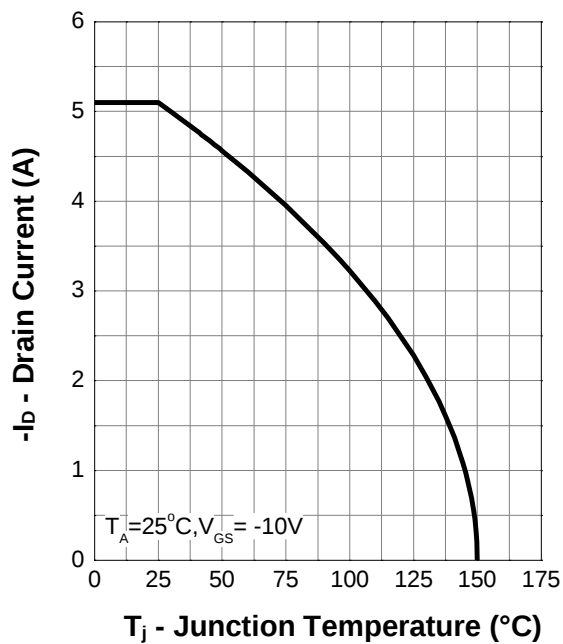
## 8. Typical Characteristics (Cont.)

P-channel:

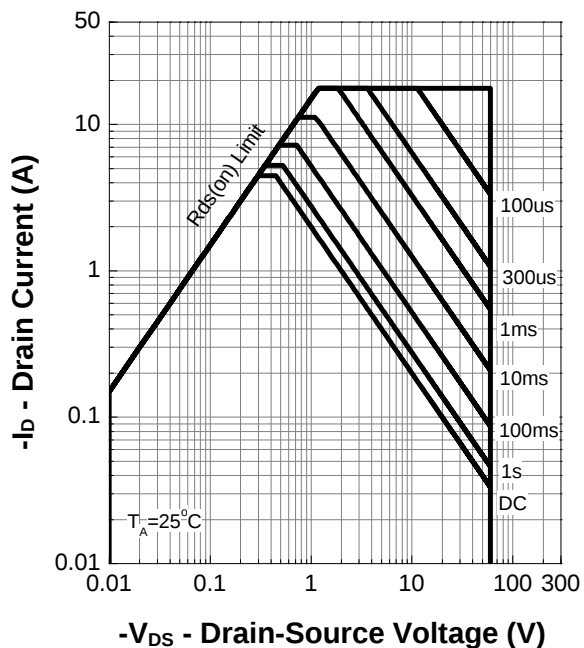
Power Capability



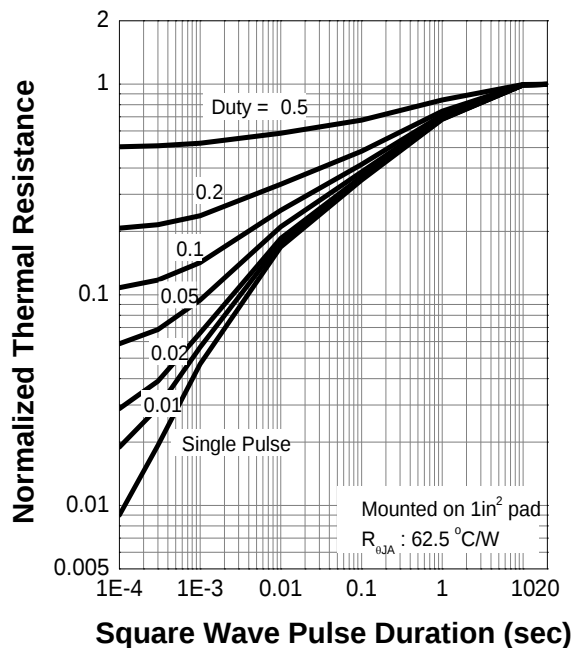
Current Capability



Safe Operation Area



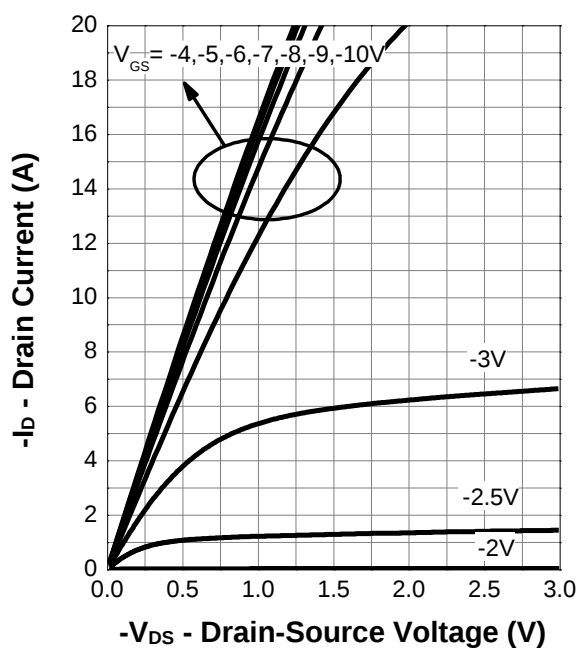
Transient Thermal Impedance



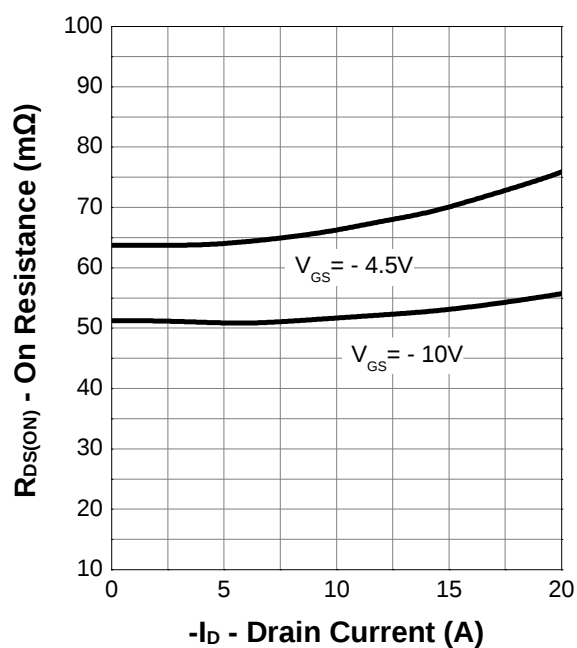
## 8. Typical Characteristics (Cont.)

P-channel:

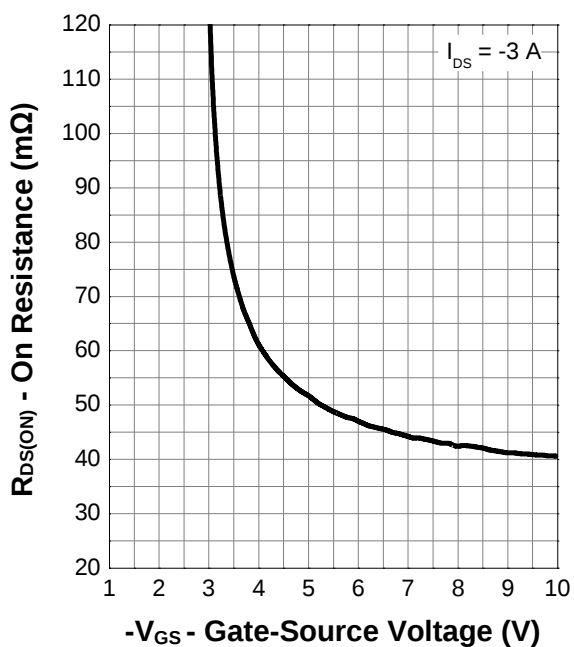
Output Characteristics



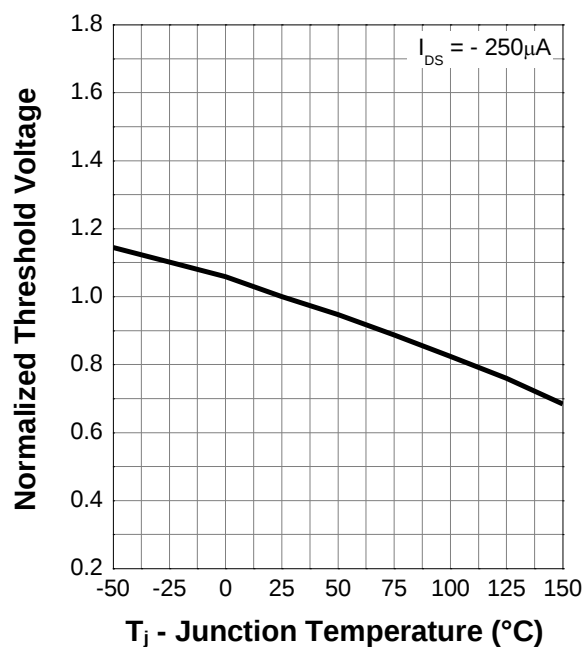
Drain-Source On Resistance



Transfer Characteristics



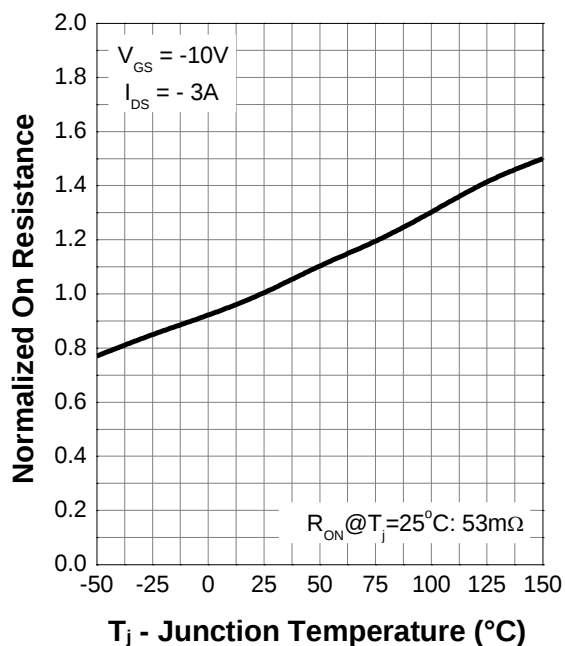
Normalized Threshold Voltage



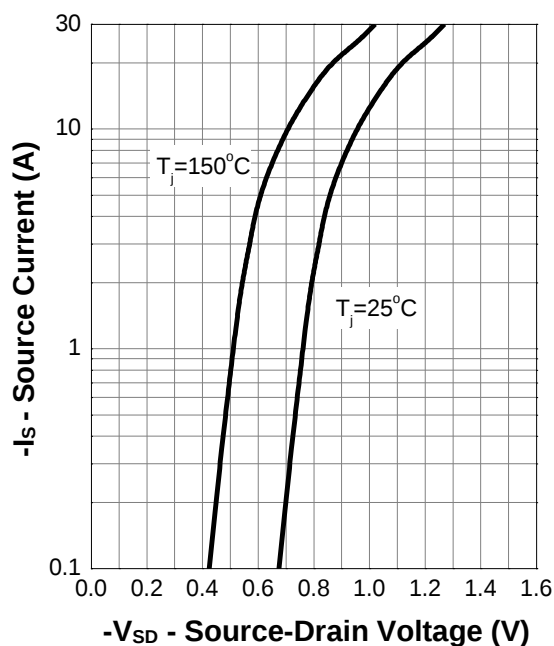
## 8. Typical Characteristics (Cont.)

P-channel:

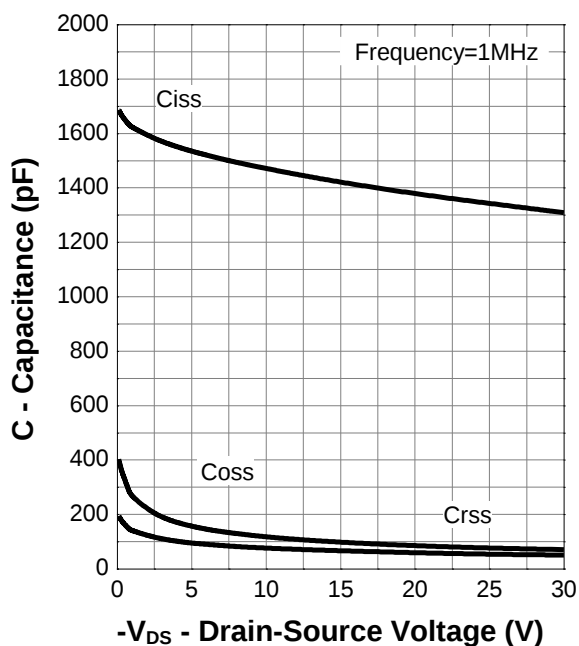
Normalized On Resistance



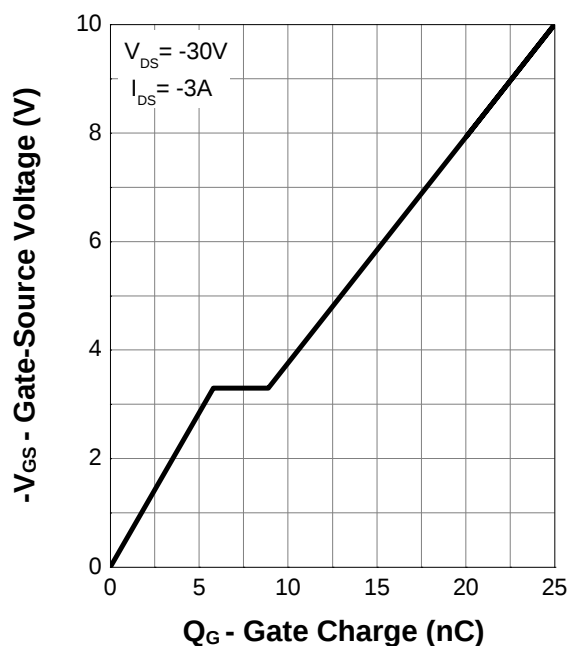
Diode Forward Current



Capacitance

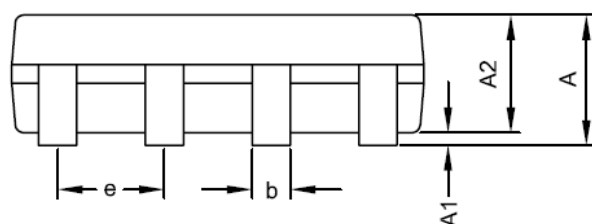
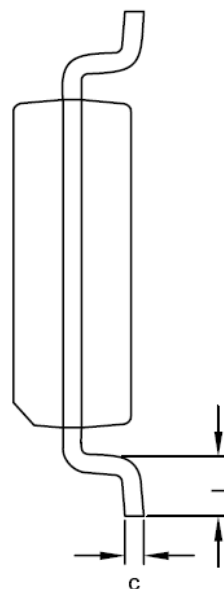
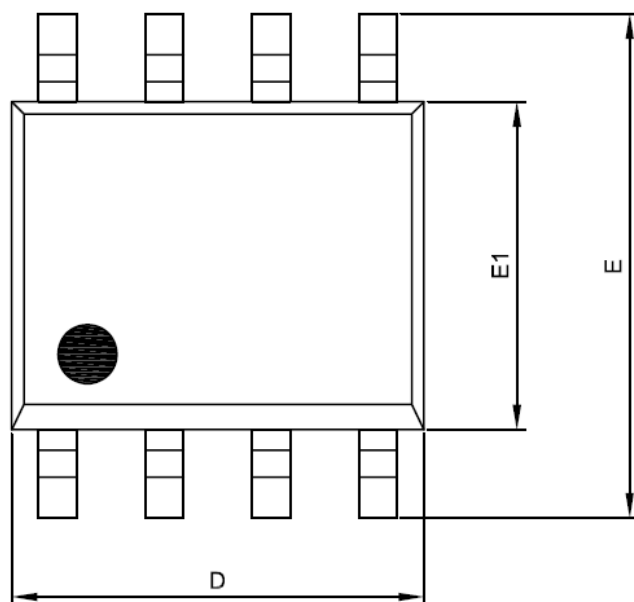


Gate Charge



## 9. Package Dimensions

SOP- 8L



| Symbol | Dimensions In Millimeters |      |
|--------|---------------------------|------|
|        | MIN.                      | MAX. |
| A      | 1.35                      | 1.75 |
| A1     | 0.00                      | 0.25 |
| A2     | 1.15                      | 1.50 |
| D      | 4.80                      | 5.00 |
| E      | 5.80                      | 6.20 |
| E1     | 3.80                      | 4.00 |
| c      | 0.19                      | 0.27 |
| b      | 0.33                      | 0.53 |
| e      | 1.27 BSC                  |      |
| L      | 0.40                      | 1.27 |

Notes :

1. Jedec outline : MS-012AA
2. Dimensions " D " does not include mold flash, protrusions and gate burrs shall not exceed .15 mm (.006 in) per side .
3. Dimensions " E1 " does not include inter-lead flash, or protrusions. Inter-lead flash and protrusions shall not exceed .25 mm (.010 in) per side.